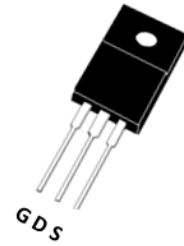


## 100V N-Channel Power MOSFET

### DESCRIPTION :

- Fast Recovery Body Diode
- Low Gate Charge Minimize Switching Loss
- Proprietary New Trench Technology
- $R_{DS(ON),typ.}=13.5m\Omega@V_{GS}=10V$
- RoHS compliant

$BV_{DSS}$	100V
$I_D$	50A
$R_{DS(ON),typ.}$	13.5m $\Omega$



ITO-220AB

### TYPICAL APPLICATIONS :

- Synchronous Rectification
- UPS Inverter

### MAXIMUM RATINGS (at $T_C = 25^\circ C$ , unless otherwise specified)

Characteristic	Condition	Symbol	Value	Unit
Drain-Source Voltage		$V_{DSS}$	100	V
Gate-Source Voltage		$V_{GSS}$	$\pm 20$	V
Continuous Drain Current	$T_C=25^\circ C$ $T_C=100^\circ C$	$I_D$	50 36	A
Pulsed Drain Current <sup>(1)</sup>	$V_{GS}=10V$	$I_{DM}$	150	A
Single Pulsed Avalanche Energy	$L=1.0mH$	$E_{AS}$	100	mJ
Power dissipation		$P_D$	83	W
Junction & Storage temperature Range		$T_J, T_{STG}$	-55~+150	$^\circ C$

Notes : 1. Repetitive rating; pulse width limited by maximum junction temperature.

### THERMAL CHARACTERISTICS

Characteristic	Condition	Symbol	Value	Unit
Thermal resistance,	Junction – Ambient Junction - Case	$R_{\theta(j-A)}$ $R_{\theta(j-C)}$	62 1.5	$^\circ C/W$

ELECTRICAL CHARACTERISTICS (at  $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage VGS = 0V, ID = 250uA	BV <sub>DSS</sub>	100			V
Zero Gate Voltage Drain Current VDS = 100 V, VGS = 0 V Tj=25°C	I <sub>DSS</sub>			1	uA
Gate-Source Leakage Current VGS = ±20V, VDS = 0V	I <sub>GSS</sub>			±100	nA
Gate-Source threshold voltage VDS = VGS, ID = 250uA	V <sub>GS(th)</sub>	2.0		4.0	V
Drain-Source On-State Resistance VGS = 10V, ID = 20A	R <sub>DS(on)</sub>		13.5	16	mΩ
Input capacitance f=1MHz, VDS=50 V, VGS=0 V	C <sub>iss</sub>		1243		pF
Output capacitance f=1MHz, VDS=50 V, VGS=0 V	C <sub>oss</sub>		224		pF
Reverse transfer capacitance f=1MHz, VDS=50 V, VGS=0 V	C <sub>rss</sub>		6.3		pF
Total Gate Charge VDD= 50V, ID= 20A, VGS= 10V	Q <sub>G</sub>		20		nC
Gate to Source Charge VDD= 50V, ID= 20A, VGS= 10V	Q <sub>GS</sub>		5.5		nC
Gate to Drain Charge VDD= 50V, ID= 20A, VGS= 10V	Q <sub>GD</sub>		5.8		nC
Turn-on delay time VDD=50 V, VGS= 10V, ID= 20A, R <sub>GEN</sub> =2.0Ω	t <sub>d(ON)</sub>		15.5		ns
Turn-on Rise time VDD=50 V, VGS= 10V, ID= 20A, R <sub>GEN</sub> =2.0Ω	t <sub>r</sub>		4.5		ns
Turn-off delay time VDD=50 V, VGS= 10V, ID= 20A, R <sub>GEN</sub> =2.0Ω	t <sub>d(OFF)</sub>		30.5		ns
Turn-off Fall time VDD=50 V, VGS= 10V, ID= 20A, R <sub>GEN</sub> =2.0Ω	t <sub>f</sub>		5.5		ns

## Body Diode

ELECTRICAL CHARACTERISTICS (at  $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Diode Forward Voltage $V_{GS} = 0V, I_S = 40A$	$V_{SD}$			1.2	V
Continuous Source Current	$I_{SD}$			50	A
Revers Recovery Time $I_F = 20A, dI_F/dt = 100A/\mu s$	$T_{rr}$		49		ns
Revers Recovery Charge $I_F = 20A, dI_F/dt = 100A/\mu s$	$Q_{rr}$		58.5		nC

Typical Characteristics

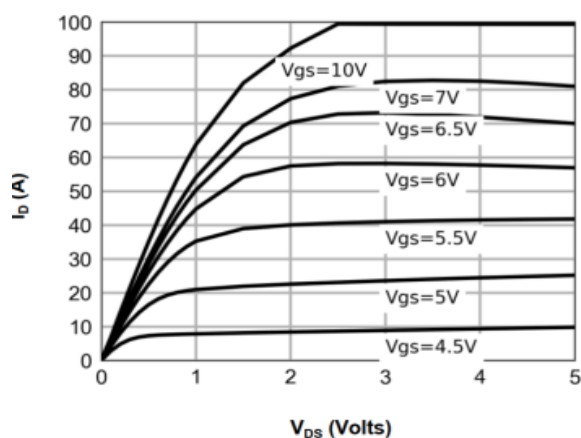


Figure 1. On-Region Characteristics

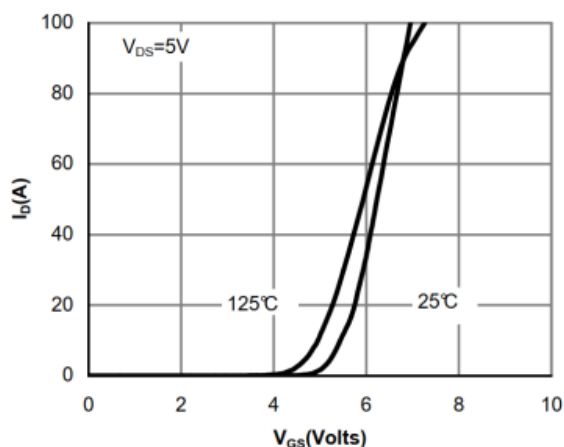


Figure 2. Transfer Characteristics

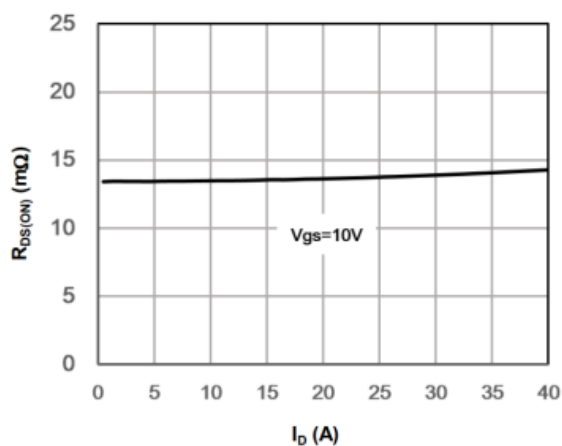


Figure 3. On-resistance vs. Drain Current and Gate Voltage

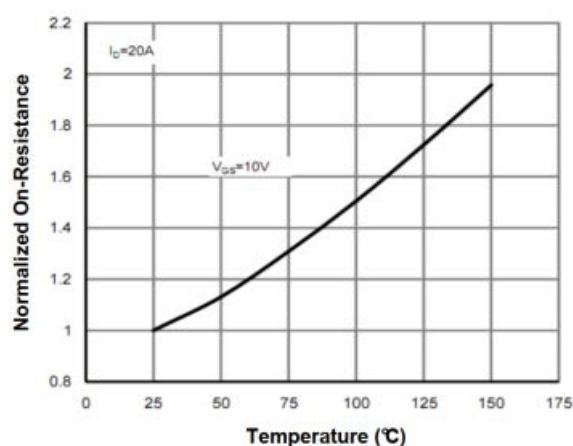


Figure 4. On-resistance vs. Junction Temperature

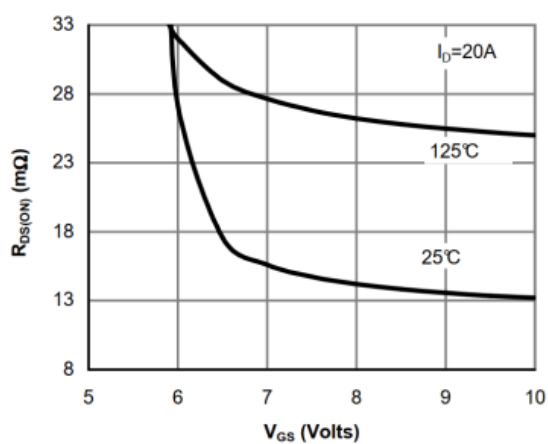


Figure 5. On-resistance vs. Gate-Source Voltage

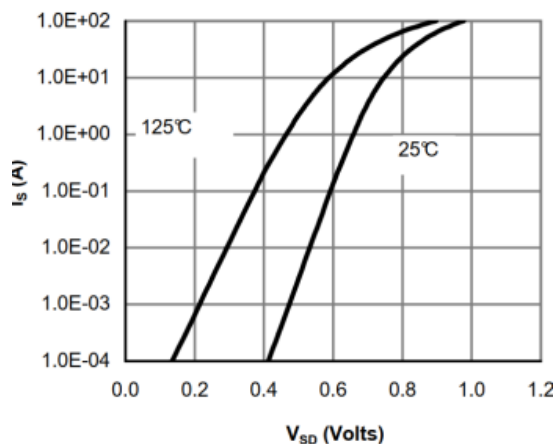


Figure 6. Body-Diode Characteristics

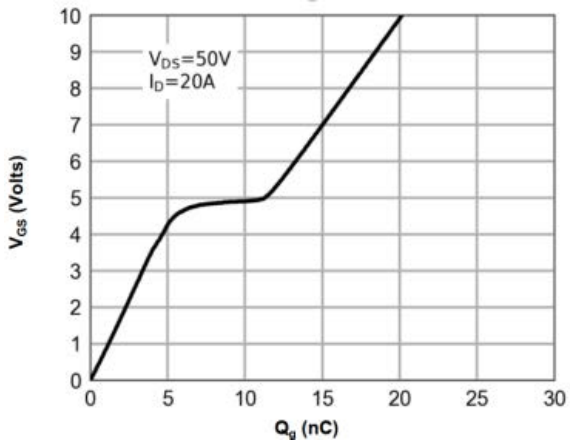


Figure 7. Gate Charge Characteristics

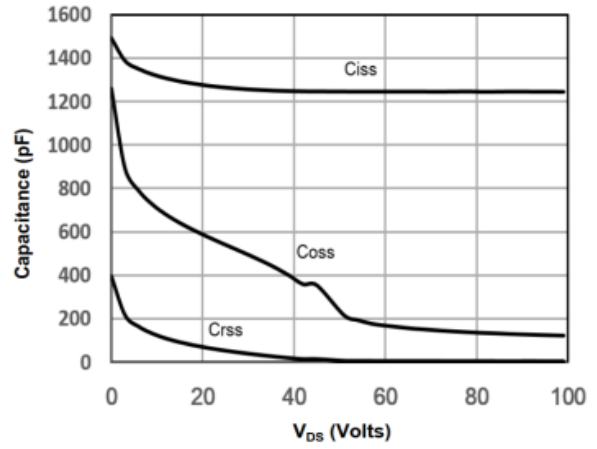


Figure 8. Capacitance Characteristics

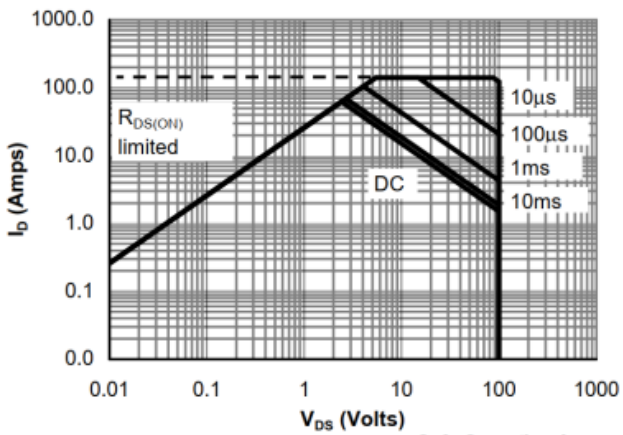
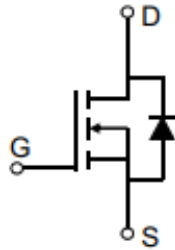
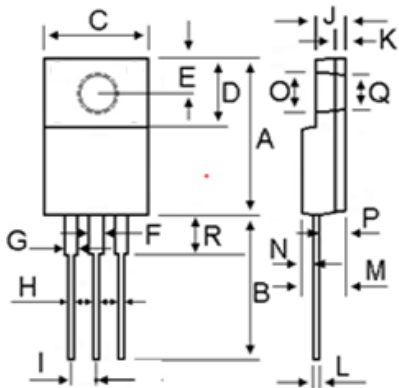


Figure 9. Safe Operating Area

- Circuit diagram



- ITO-220AB Package outlines : Dimensions in (mm)



DIM	MILLIMETERS	
	MIN	MAX
A	14.80	16.10
B	12.65	14.40
C	9.70	10.36
D	4.60	6.80
E	2.50	3.50
F	0.90	1.55
G	0.90	1.55
H	0.50	0.90
I	2.40	2.70
J	2.34	3.30
K	0.55	1.30
L	0.36	0.80
M	4.20	4.90
N	1.10	1.80
O	2.90	3.50
P	2.30	3.15
Q	2.90	3.50
R	2.80	4.85

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